

#### Discription

The UCLAMP2804L.TCT protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.

#### Features

- 550W peak pulse power (8/20µs)
- Protects two line pairs (four lines)
- Ultra low leakage: nA level
- Low operating voltage: 2.8V
- Very low capacitance:1pF
- Ultra low clamping voltage
- JEDEC SOP-8 package
- Complies with following standards:
  - IEC 61000-4-2 (ESD) immunity test
     Air discharge: ±30kV
    - Contact discharge: ±30kV
  - IEC61000-4-5 (Lightning) 30A (8/20µs)
- RoHS Compliant

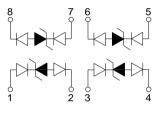
## **Ordering Information**

Product ID	Pack	Qty(PCS)
UCLAMP2804L.TCT	SOP-8	3000

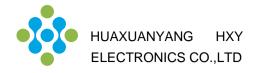
## Absolute Ratings(Tamb = 25°C)

Symbol	Parameter		Value	Units
P <sub>PP</sub>	Peak Pulse Power ( $t_p = 8/20 \ \mu \ s$ )	550	W	
ΤL	Maximum lead temperature for soldering during 10s	260	°C	
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C
T <sub>op</sub>	Operating Temperature Range		-55 to +150	°C
Tj	Maximum junction temperature		150	°C
	IEC61000-4-2 (ESD)	air discharge contact discharge	±30 ±30	KV
	IEC61000-4-4 (EFT)		40	А





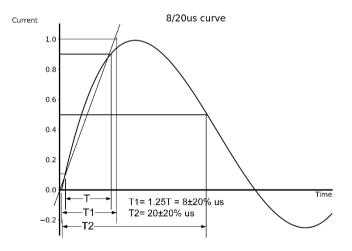
Circuit Diagram



## Electrical Characteristics Ratings at 25°C

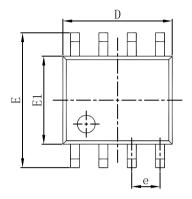
Parameter	Symbol	Min	Тур	Max	Unit	Test Condition	
Reverse Working Voltage	Vrwm			2.8	V		
Breakdown Voltage	Vbr	3.0			V	Ιτ = 2μΑ	
	Vsb	3.0			V	ISB= 50mA	
Reverse Leakage Current	I <sub>R</sub>			1	μA	VRWM = 2.8V	
Clamping Voltage	Vc		6		V	IPP = 1A (8 x 20µs pulse)	
Clamping Voltage	Vc		16		V	IPP = 30A (8 x 20µs pulse)	
Junction Capacitance	CJ		1		pF	VR = 0V, f = 1MHz	

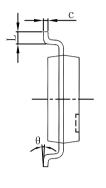
# **Typical Characteristics**

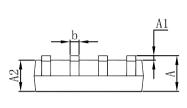




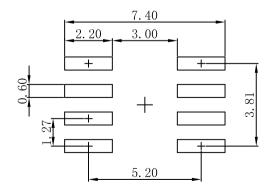
## **SOP-8** Package Information







Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0.197	
e	1.270 (BSC)		0.050 (BSC)		
E	5.800	6.200	0.228	0.244	
E1	3.800	4.000	0.150	0.157	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0 °	8°	



Note: 1.Controlling dimension:in millimeters.

2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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